# SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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'174, 'LS174, 'S174 . . . HEX D-TYPE FLIP-FLOPS '175, 'LS175, 'S175 . . . QUADRUPLE D-TYPE FLIP-FLOPS

- '174, 'LS174, 'S174 Contain Six Flip-Flops with Single-Rail Outputs
- '175, 'LS175, 'S175 Contain Four Flip-Flops with Double-Rail Outputs
- Three Performance Ranges Offered: See Table Lower Right
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications include: Buffer/Storage Registers Shift Registers

Pattern Generators

#### description

These monolithic, positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. All have a direct clear input, and the '175, 'LS175, and 'S175 feature complementary outputs from each flipflop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

These circuits are fully compatible for use with most TTL circuits.

FUNCTION TABLE												
(EACH FLIP-FLOP)												
	NPUTS		ουτ	PUTS								
CLEAR	CLOCK	D	٩	ā۲								
L L	x	х	L	н								
н	1	н	н	L								
н	1	L	L	н								
н	L	х	a <sub>0</sub>	₫ <sub>0</sub>								

H = high level (steady state)

L = low level (steady state)

X = irrelevant

t = transition from low to high level

 $\Omega_0$  = the level of  $\Omega$  before the indicated steady-state

input conditions were established. † = '175, 'LS175, and 'S175 only

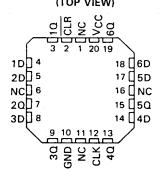
	TYPICAL	TYPICAL
TYPES	MAXIMUM	POWER
TTFES	CLOCK	DISSIPATION
	FREQUENCY	PER FLIP-FLOP
'174, '175	35 MHz	38 mW
'LS174, 'LS175	40 MHz	14 mW
'S174, 'S175	110 MHz	75 mW

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

SN54174, SN54LS174, SN54S174 J OR W PACKAGE
SN74174 N PACKAGE
SN74LS174, SN74S174, D OR N PACKAGE

(TOP VIEW) 10 2 15 60 1D 🛛 3 14 🗌 6D 13 0 5D 2D 4 20 5 12 50 3D 🗌 6 11 🗌 4D 30 07 10 40 GND 8 9 CLK

SN54LS174, SN54S174 . . . FK PACKAGE (TOP VIEW)

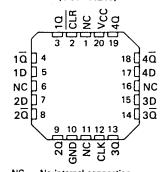


SN54175, SN54LS175, SN54S175...J OR W PACKAGE SN74175...N PACKAGE

SN74LS175, SN74S175...D OR N PACKAGE (TOP VIEW)

•		•
	hτ	
10[	2	15 40
١āĽ	3	14 🛛 40
1 D 🗌	4	13 🗍 4 D
2 D 🗌	5	12 🗍 3 D
2 <u>0</u> [	6	11]] 30
20	]7	10 🛛 30.
GND	8	9 СLК

#### SN54LS175, SN54S175 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

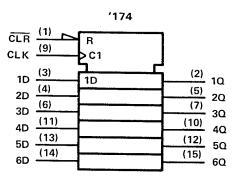
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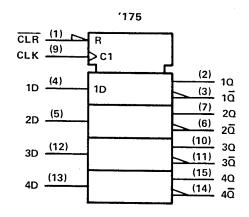
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# SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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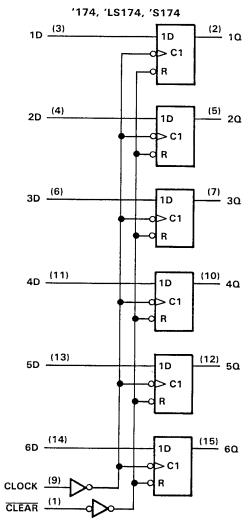
logic symbols<sup>†</sup>





<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

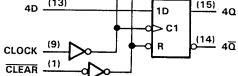
## logic diagrams (positive logic)



1D <u>(4)</u> <u>(2)</u> 10 1D > C1<u>(3)</u> 10 R (7) 20 (5) 2D 1D > C1 <u>(6)</u> 20 R 3D (12) (10) 30 1D ⊳cı <u>(11)</u> 30 R (15) 40 4D (13) 1D

'175, 'LS175, 'S175

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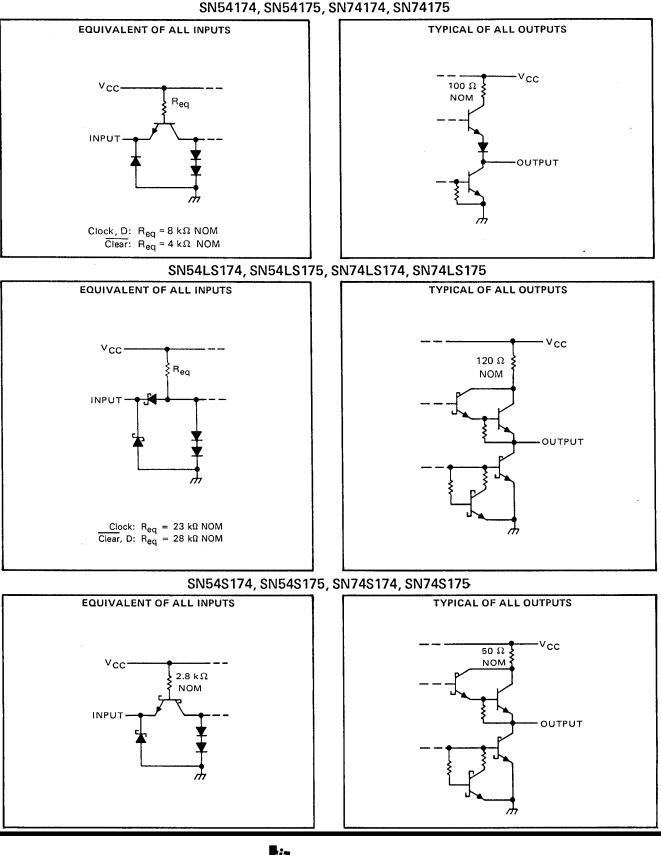
Pin numbers shown are for D, J, N, and W packages.



# SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 **HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR**

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schematics of inputs and outputs





# SN54174, SN54175, SN74174, SN74175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

absolute maximum ratings over operating free-air temperature ratio	ange (unless otherwise noted)
Supply voltage, V <sub>CC</sub> (see Note 1)	
Input voltage	
Operating free-air temperature range: SN54174, SN54175 Circuits	
SN74174, SN74175 Circuits	$\ldots$ $\ldots$ $\ldots$ $\ldots$ $\ldots$ $\ldots$ $\ldots$ $\ldots$ $0^{\circ}$ C to $70^{\circ}$ C
Storage temperature range	$-65^{\circ}C$ to $150^{\circ}C$

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN54	174, SN	54175	SN74	SN74174, SN74175			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH				-800			-800	μA	
Low-level output current, IOL				16	[		16	mA	
Clock frequency, fclock		0		25	0		25	MHz	
Width of clock or clear pulse, tw		20			20			ns	
Cotum time t	Data input	20			20			ns	
Setup time, t <sub>su</sub>	Clear inactive-state	25			25			ns	
Data hold time, t <sub>h</sub>		5			5			ns	
Operating free-air temperature, TA		-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIC	NS <sup>†</sup>	MIN	<b>ΤΥΡ</b> ‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	$V_{CC} = MIN, I_I = -12$	mA			-1.5	V
V <sub>ОН</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -		2.4	3.4		v
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16			0.2	0.4	v
-μ	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>1</sub> = 5.5	V			1	mA
Чн	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4	V			40	μA
կլ	Low-level input current	$V_{CC} = MAX, V_I = 0.4$	V			-1.6	mA
1.			SN54'	-20		-57	
los	Short-circuit output current §	V <sub>CC</sub> = MAX	SN74'	-18		-57	mA
1	Current		2 '174		45	65	
1CC	Supply current	V <sub>CC</sub> = MAX, See Note	2 /175		30	45	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

<sup>‡</sup>All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

\$ Not more than one output should be shorted at a time.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I<sub>CC</sub> is measured after a momentary ground, then 4.5 V, is applied to clock.

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
f <sub>max</sub>	Maximum clock frequency		25	35		MHz
	Propagation delay time, low-to-high-level output from clear			16 23	25	
<sup>t</sup> PLH	(SN54175, SN74175 only)	$C_L = 15  \text{pF},$			25	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low-level output from clear	R <sub>L</sub> = 400 Ω, See Note 3			35	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		20	30	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low-level output from clock			24	35	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



# SN54LS174, SN54LS175, SN74LS174, SN74LS175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range	(un	le	SS	ot	he	rw	ise	e n	101	tec	1)			÷	
Supply voltage, V <sub>CC</sub> (see Note 1)		•						•			•		•	•	7 V
Input voltage															
Operating free-air temperature range: SN54LS174, SN54LS175 Circuits							•		•			-55	5°C	c to	125°C
SN74LS174, SN74LS175 Circuits			. '										$0^{\circ}$	'C to	o 70°C
Storage temperature range		•	•	•	•	•	•	•	•	•		-65	5°C	C to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN	154LS1	74	SN	UNIT		
		SI	<b>V54LS1</b>	75	SN			
		MIŅ	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH	······································			-400			-400	μA
Low-level output current, IOL	······································			4			8	mA
Clock frequency, fclock		0		30	0		30	MHz
Width of clock or clear pulse, t <sub>w</sub>		20			20			ns
Sotup time t	Data input	20			20			ns
Setup time, t <sub>su</sub>	Clear inactive-state	25			25			ns
Data hold time, th		5			5			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS <sup>†</sup>			-	N54LS1 N54LS1		S S	UNIT		
		1			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage				2			2		~~~	V
VIL	Low-level input voltage						0.7			0.8	V
٧ <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN,	l <sub>1</sub> = -18 mA				-1.5			-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = -400 μA	λ	2.5	3.5		2.7	3.5		v
Vol	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max		IOL = 4 mA		0.25	0.4		0.25 0.35	0.4	V
łı	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
Чн	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				20			20	μA
կլ	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V <sub>CC</sub> = MAX			-20		100	-20		-100	mA
Icc	Supply current	Vcc = MAX,	See Note 2	'LS174		16	26		16	26	mA
			VCC - WAX, See Note 2 'L			11	18		11	18	

<sup>1</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

\$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I<sub>CC</sub> is measured after a momentary ground, then 4.5 V, is applied to clock.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PABAMETER	TEST CONDITIONS		'LS174					
FANAMETEN	TEST CONDITIONS	MIN	түр	MAX	MIN	ТҮР	MAX	UNIT
f <sub>max</sub> Maximum clock frequency		30	40		30	40		MHz
tPLH Propagation delay time, low-to-high-level output from clear	C <sub>L</sub> = 15 pF,					20	30	ns
tphL Propagation delay time, high-to-low-level output from clear	$R_{\rm L} = 2  k \Omega$ ,		23	35	t	20	30	ns
tPLH Propagation delay time, low-to-high-level output from clock	See Note 3		20	30		13	25	ns
tphL Propagation delay time, high-to-low-level output from clock	1		21	30		16	25	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



# SN54S174, SN54S175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54S174, SN54S175 Circuits	$55^{\circ}C$ to $125^{\circ}C$
SN74S174, SN74S175 Circuits	$ 0^{\circ}C to 70^{\circ}C$
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN54S	174, SN	54S175	SN74S	174, SN	74S175	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH	······			-1			-1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, fclock		0		75	0		75	MHz
Pulso width t	Clock	7			7			
Pulse width, t <sub>w</sub>	Clear	10			10			ns
Satura tima t	Data input	5			5			
Setup time, t <sub>su</sub>	Clear inactive-state	5			5			ns
Data hold time, t <sub>h</sub>		3			3			ns
Operating free-air temperature, T <sub>A</sub>		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS <sup>†</sup>		MIN	түр‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	$V_{CC} = MIN, I_I = -18 \text{ mA}$				-1.2	V
		$V_{CC} = MIN, V_{1H} = 2V,$	SN54S'	2.5	3.4		v
VOH	High-level output voltage	V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -1 mA	SN74S'	2.7	3.4		V
M		$V_{CC} = MIN, V_{IH} = 2 V,$	• • • • • • • • • • • • • • • • • • •			0.5	V
VOL	Low-level output voltage	V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA				0.5	V
lj –	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V				1	mA
ЧΗ	High-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.7 V				50	μA
ΊL	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V				-2	mA
los	Short-circuit output current §	V <sub>CC</sub> = MAX		-40		-100	mA
1	Supply support	No MAX - See Nete 2	'174		90	144	
<sup>I</sup> CC	Supply current	V <sub>CC</sub> = MAX, See Note 2	<b>'17</b> 5		60	96	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . <sup>§</sup>Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, ICC is measured after a momentary ground, then 4.5 V, is applied to clock.

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	түр	MAX	UNIT
f <sub>max</sub>	Maximum clock frequency		75	110		MHz
₽LH	Propagation delay time, low-to-high-level $\overline{\Omega}$ output from clear (SN54S175, SN74S175 only)	С <sub>L</sub> = 15 рF,		10	15	ns
t₽HL	Propagation delay time, high-to-low-level Q output from clear	$R_{L} = 280 \Omega,$ See Note 3		13	22	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		8	12	ns
<sup>t</sup> PHL	Propagation time, high-to-low-level output from clock			11.5	17	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





# PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07105BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
JM38510/07105BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
JM38510/07106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
JM38510/30106B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
JM38510/30106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
JM38510/30106BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
JM38510/30107B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples
JM38510/30107BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
JM38510/30107BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
M38510/07105BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
M38510/07105BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
M38510/07106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
M38510/30106B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
M38510/30106BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
M38510/30106BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
M38510/30107B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30107BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
M38510/30107BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
SN54LS174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS174J	Samples
SN54LS175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS175J	Samples
SN54S174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S174J	Samples
SN54S175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S175J	Samples
SN74LS174D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	LS174	
SN74LS174DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS174	Samples
SN74LS174N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS174N	Samples
SN74LS174NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS174	Samples
SN74LS175D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	LS175	
SN74LS175DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS175	Samples
SN74LS175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Samples
SN74LS175NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Samples
SN74LS175NSR	ACTIVE	SOP	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS175	Samples
SN74S175D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S175	Samples
SN74S175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S175N	Samples
SNJ54LS174FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 174FK	Samples
SNJ54LS174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174J	Samples
SNJ54LS174W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174W	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS175FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 175FK	Samples
SNJ54LS175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175J	Samples
SNJ54LS175W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175W	Samples
SNJ54S174J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174J	Samples
SNJ54S174W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174W	Samples
SNJ54S175J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S175J	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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#### OTHER QUALIFIED VERSIONS OF SN54LS174, SN54LS175, SN54S175, SN74LS174, SN74LS175, SN74S175 :

- Catalog : SN74LS174, SN74LS175, SN74S175
- Military : SN54LS174, SN54LS175, SN54S175

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

\*All dimensions are nominal

STRUMENTS

## TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS174DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS174NSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS175DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS175NSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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# PACKAGE MATERIALS INFORMATION

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\*All dimensions are nominal

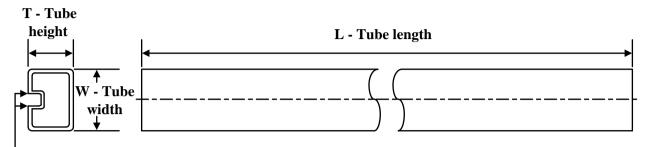
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS174DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LS174NSR	SOP	NS	16	2000	356.0	356.0	35.0
SN74LS175DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS175NSR	SOP	NS	16	2000	356.0	356.0	35.0

# TEXAS INSTRUMENTS

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# TUBE



# - B - Alignment groove width

*All dimensions are nominal	*All	dimensions	are	nominal	
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Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
JM38510/07105BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30106B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30106BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30107B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30107BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/07105BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30106B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30106BFA	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30107B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30107BFA	W	CFP	16	25	506.98	26.16	6220	NA
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175D	D	SOIC	16	40	507	8	3940	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS174FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS174W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS175FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS175W	W	CFP	16	25	506.98	26.16	6220	NA

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